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(54) **DISPLAY PANEL AND METHOD OF MANUFACTURING DISPLAY PANEL**

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(57) **ABSTRACT**

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Provided is a method for manufacturing a display panel, the method includes forming a driving element layer including a transistor and a first insulation layer on a base layer; forming a contact-hole partially exposing the transistor; and providing a connection wiring electrically connected to the transistor through the contact-hole on the first insulation layer. The method includes forming a first tip portion by performing a primary etching on the connection wiring; providing the first tip portion exposed by the first open region as a second preliminary tip portion; and forming a second tip portion by performing a secondary etching on the second preliminary tip portion.

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